

**General Description**

The SJS30P410 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as -4.5V. This device is suitable for use as a wide variety of applications.

**Features**

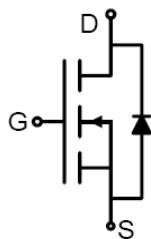
- Low Gate Charge
- High Power and current handing capability
- Lead free product is acquired

**Application**

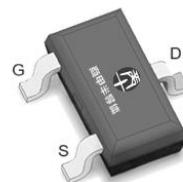
- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

**Key Performance Parametes**

Parameter	Value	Unit
$V_{DS}$	-30	V
$R_{DS(ON)}_{TYP}$	40	$m\Omega$
$I_D$	-4.1	A
$Q_G$	11	nC



Schematic Diagram



SOT-23 top view

**Package Marking and Ordering Information**

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJS30P410	3002	SOT-23	Tape	\	\	3000 Pcs

**Table 1. Absolute Maximum Ratings ( $T_A=25^\circ C$  unless otherwise noted)**

Symbol	Parameter	Limit	Unit
$V_{DS}$	Drain-Source Voltage ( $V_{GS}=0V$ )	-30	V
$V_{GS}$	Gate-Source Voltage ( $V_{DS}=0V$ )	$\pm 20$	V
$I_D$	Drain Current-Continuous( $T_A=25^\circ C$ )	-4.1	A
	Drain Current-Continuous( $T_A=100^\circ C$ )	-2.6	A
$I_{DM}$ (pulse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	-16.4	A
$P_D$	Maximum Power Dissipation( $T_A=25^\circ C$ )	1.4	W
	Maximum Power Dissipation( $T_A=100^\circ C$ )	0.6	W
$E_{AS}$	Avalanche energy (Note 2)	30	mJ
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	-55 To 150	°C

**Table 2. Thermal Characteristic**

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		90	°C/W



## 30V P-Channel Trench Power MOSFET

Table 3. Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>On/Off States</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ $I_{\text{D}}=250\mu\text{A}$	-30			V
$I_{\text{DS}}^{\text{SS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}=-30\text{V}$ , $V_{\text{GS}}=0\text{V}$ $T_J=25^\circ\text{C}$			-1	$\mu\text{A}$
		$V_{\text{DS}}=-30\text{V}$ , $V_{\text{GS}}=0\text{V}$ $T_J=125^\circ\text{C}$			-100	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$			$\pm 100$	nA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$ , $I_{\text{D}}=250\mu\text{A}$	-1.2		-0.5	V
$g_{\text{FS}}$	Forward Transconductance	$V_{\text{DS}}=-5\text{V}$ , $I_{\text{D}}=-2\text{A}$		6.2		S
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance	$V_{\text{GS}}=-10\text{V}$ , $I_{\text{D}}=-2\text{A}$ $T_J=25^\circ\text{C}$		40	52	$\text{m}\Omega$
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance	$V_{\text{GS}}=-4.5\text{V}$ , $I_{\text{D}}=-1.5\text{A}$ $T_J=25^\circ\text{C}$		46	61	$\text{m}\Omega$
<b>Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=-15\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1.0\text{MHz}$		480		pF
$C_{\text{oss}}$	Output Capacitance			66		pF
$C_{\text{rss}}$	Reverse Transfer Capacitance			60		pF
$R_g$	Gate resistance	$V_{\text{GS}}=0\text{V}$ , $V_{\text{DS}}=0\text{V}$ , $f=1.0\text{MHz}$		11.8		$\Omega$
<b>Switching Parameters</b>						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{GS}}=-10\text{V}$ , $V_{\text{DS}}=-15\text{V}$ , $R_L=7.5\Omega$ , $R_{\text{GEN}}=3\Omega$		3		nS
$t_r$	Turn-on Rise Time			2		nS
$t_{\text{d(off)}}$	Turn-Off Delay Time			26		nS
$t_f$	Turn-Off Fall Time			15		nS
$Q_g$	Total Gate Charge	$V_{\text{GS}}=-10\text{V}$ , $V_{\text{DS}}=15\text{V}$ , $I_{\text{D}}=-2\text{A}$		11		nC
$Q_{\text{gs}}$	Gate-Source Charge			2		nC
$Q_{\text{gd}}$	Gate-Drain Charge			2		nC
<b>Source-Drain Diode Characteristics</b>						
$I_{\text{SD}}$	Source-Drain Current (Body Diode)				-4.1	A
$V_{\text{SD}}$	Forward on Voltage (Note 3)	$V_{\text{GS}}=0\text{V}$ , $I_{\text{S}}=-2\text{A}$			-1.2	V
$t_{\text{rr}}$	Reverse Recovery Time	$I_F=-2\text{A}$ , $dI/dt=100\text{A}/\mu\text{s}$		9		ns
$Q_{\text{rr}}$	Reverse Recovery Charge	$I_F=-2\text{A}$ , $dI/dt=100\text{A}/\mu\text{s}$		3		nC

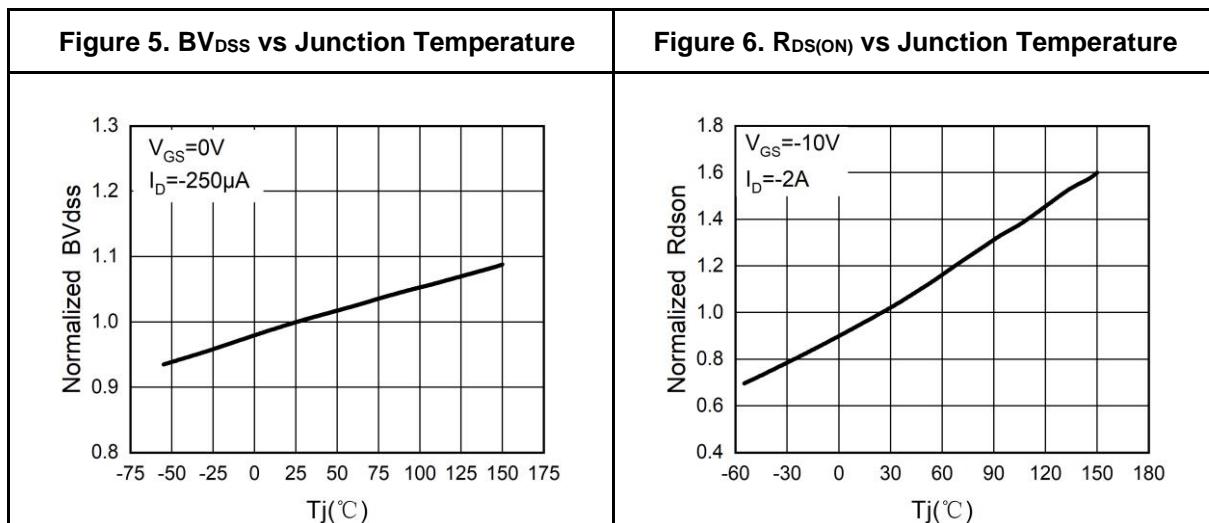
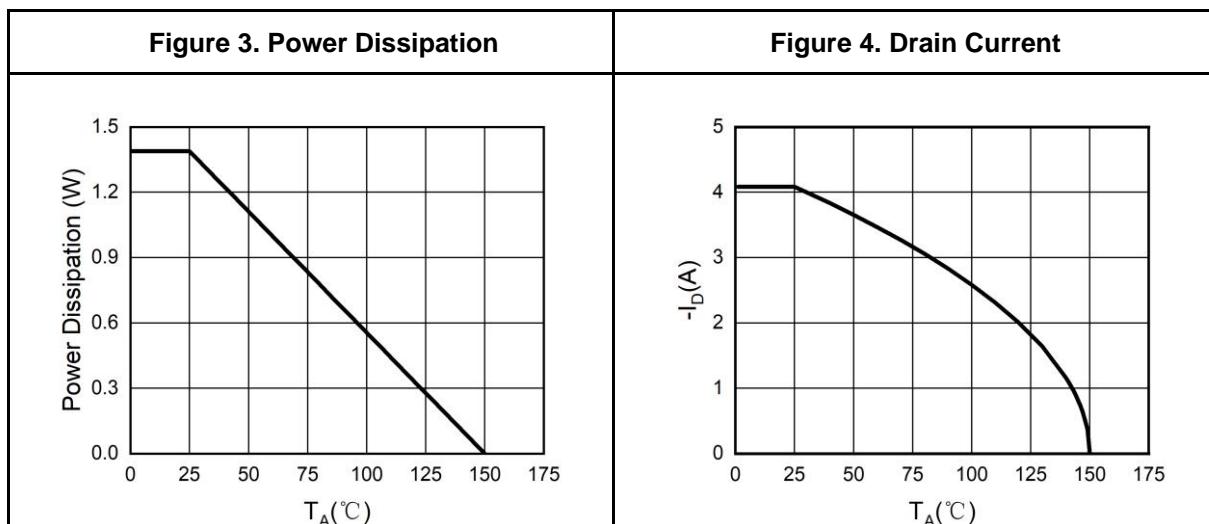
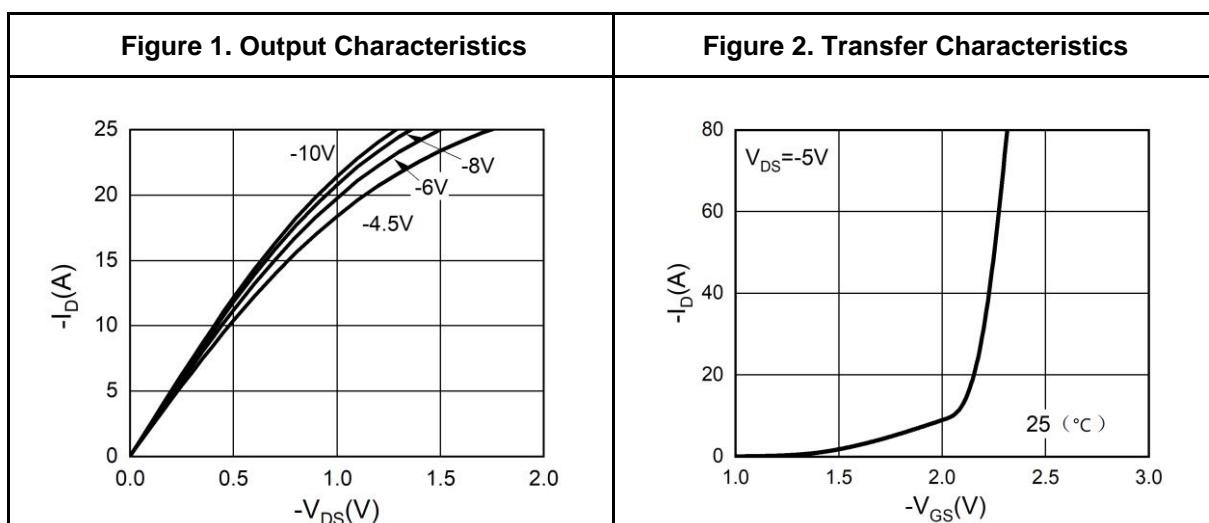
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

Notes 2.E<sub>AS</sub> condition:  $T_J=25^\circ\text{C}$ ,  $V_{\text{DD}}=-30\text{V}$ ,  $V_{\text{G}}=10\text{V}$ ,  $R_g=25\Omega$ ,  $L=0.5\text{mH}$ .

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.

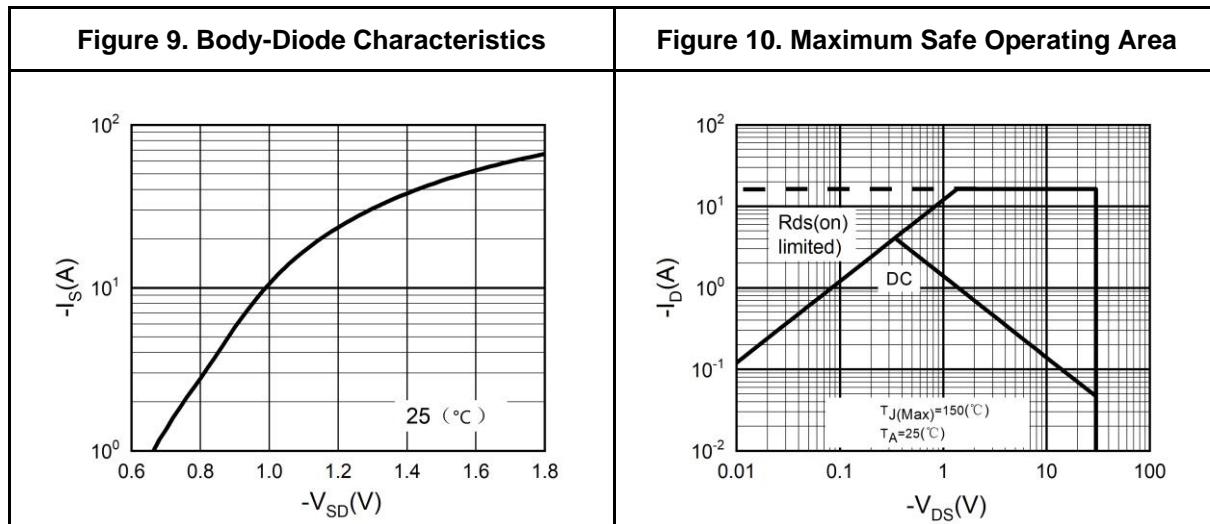
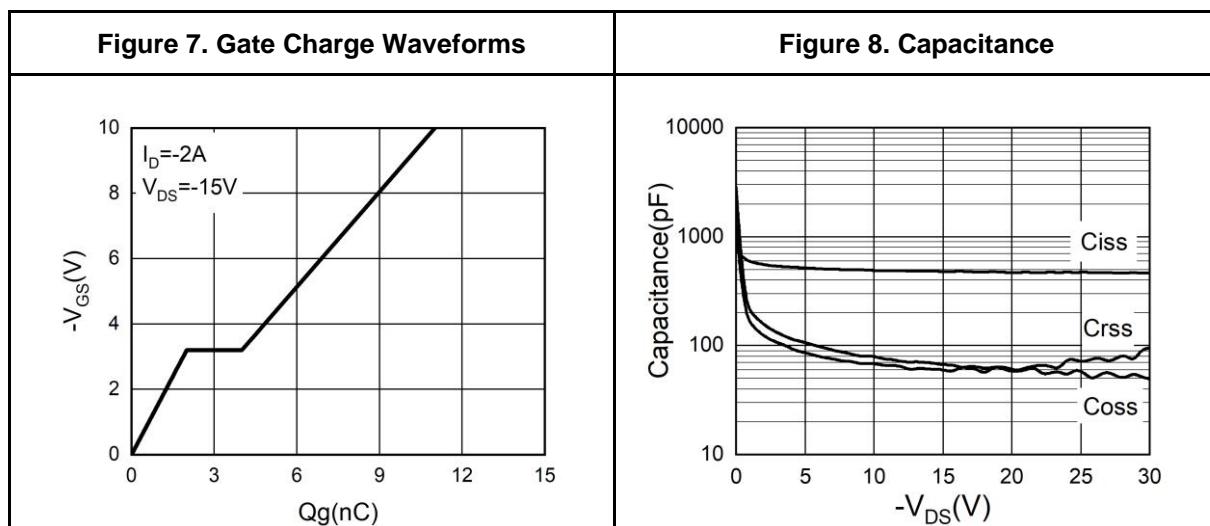


## Typical Electrical And Thermal Characteristics (Curves)



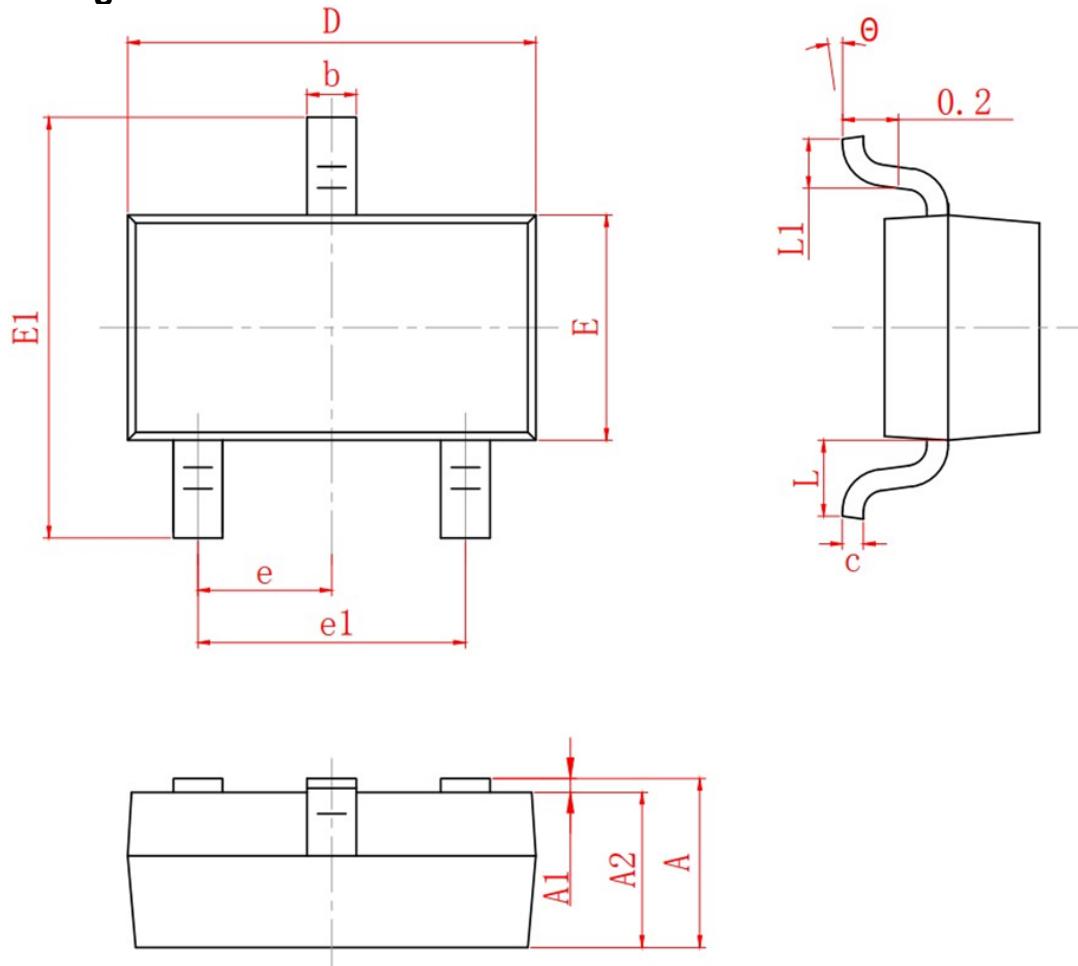


## Typical Electrical And Thermal Characteristics (Curves)





### SOT-23 Package Information



SYMBOL	MIN	NOM	MAX
A	0.90	1.05	1.20
A1	0.00	0.05	0.10
A2	0.90	1.00	1.10
b	0.30	0.40	0.50
c	0.08	0.10	0.15
D	2.80	2.90	3.00
E	1.20	1.30	1.40
E1	2.30	2.40	2.50
L	0.30	0.40	0.50
θ	0°	5°	10°
L1	0.55 REF		
e	0.95 BSC		
e1	1.90 REF		



## Attention

This product described in this document can not be used in life support devices or systems, aircraft's control systems, and other applications whose failure can be reasonably expected to result in serious physical and/or material damage, apart from that when an application agreement is signed between customer and Wuxi Shangjia Semiconductor.

The performances and characteristics of this product in the independent testing state are displayed in this document. Wuxi Shangjia Semiconductor can't guarantee of the performances and characteristics of this described product that mounted in the customer's products or equipments as same as that in the independent testing state. So the customer should evaluate and test devices mounted in the customer's products or equipments.

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